

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Jose M. Capilla	01/22/2007
Olivier Causse	01/22/2007
RECEIVING PARTY DATA	
Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
Street Address:	5005 E. McDowell Road
Internal Address:	Patent Administration-A242
City:	Phoenix
State/Country:	ARIZONA
Postal Code:	85008
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12891277
CORRESPONDENCE DATA	
Fax Number:	(602)244-3169
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	602-244-6648
Email:	PATENTS@ONSEMI.COM
Correspondent Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
Address Line 1:	5005 E. MCDOWELL ROAD, P.O.BOX 62890
Address Line 4:	PHOENIX, ARIZONA 85082
ATTORNEY DOCKET NUMBER:	ONS00762F2DP1
NAME OF SUBMITTER:	Lydia McNamara
Total Attachments: 2 source=ONS00762F2DP1_ASSIGN#page1.tif source=ONS00762F2DP1_ASSIGN#page2.tif	

CH \$40.00 12891277

ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Name of (City/State/Country)
Jose M. Capilla TOURNEFEUILLE; France ; and
Olivier Causse LEGUEVIN, France ;

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

METHOD OF FORMING A POWER SUPPLY CONTROLLER AND STRUCTURE THEREFOR (Attorney Docket No. ONS00762F2),

described, illustrated, and claimed in an application for Letters Patent of the Patent Cooperation Treaty executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof in the United States of America.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.


We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Signed and Witnessed on (date): 01-22-2007


By (inventor signature): [Signature]
Jose M. Capilla

Witness by (signature): [Signature] Printed Name of Witness: Dominique OMET

Signed and Witnessed on (date): 01-22-2007

By (inventor signature):  _____

Olivier Causse

Witness by (signature):  _____

Printed Name of Witness:
Dominique OMET